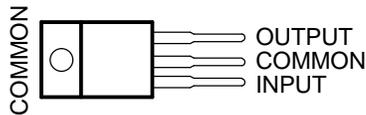


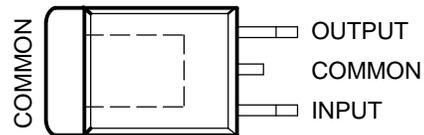
## FEATURES

- 3-Terminal Regulators
- Output Current up to 500 mA
- No External Components
- Internal Thermal-Overload Protection
- High Power-Dissipation Capability
- Internal Short-Circuit Current Limiting
- Output Transistor Safe-Area Compensation

**KC (TO-220) PACKAGE  
(TOP VIEW)**

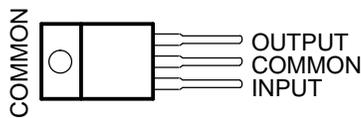


**KTP (PowerFLEX™/TO-252\*) PACKAGE  
(TOP VIEW)**

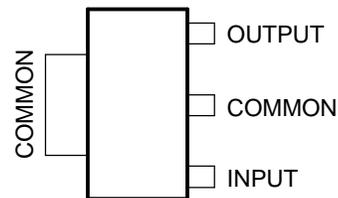


\* Complies with JEDEC TO-252, variation AC

**KCS (TO-220) PACKAGE  
(TOP VIEW)**



**DCY (SOT-223) PACKAGE  
(TOP VIEW)**



## DESCRIPTION/ORDERING INFORMATION

This series of fixed-voltage integrated-circuit voltage regulators is designed for a wide range of applications. These applications include on-card regulation for elimination of noise and distribution problems associated with single-point regulation. Each of these regulators can deliver up to 500 mA of output current. The internal current-limiting and thermal-shutdown features of these regulators essentially make them immune to overload. In addition to use as fixed-voltage regulators, these devices can be used with external components to obtain adjustable output voltages and currents and also as the power-pass element in precision regulators.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PowerFLEX, PowerPAD are trademarks of Texas Instruments.

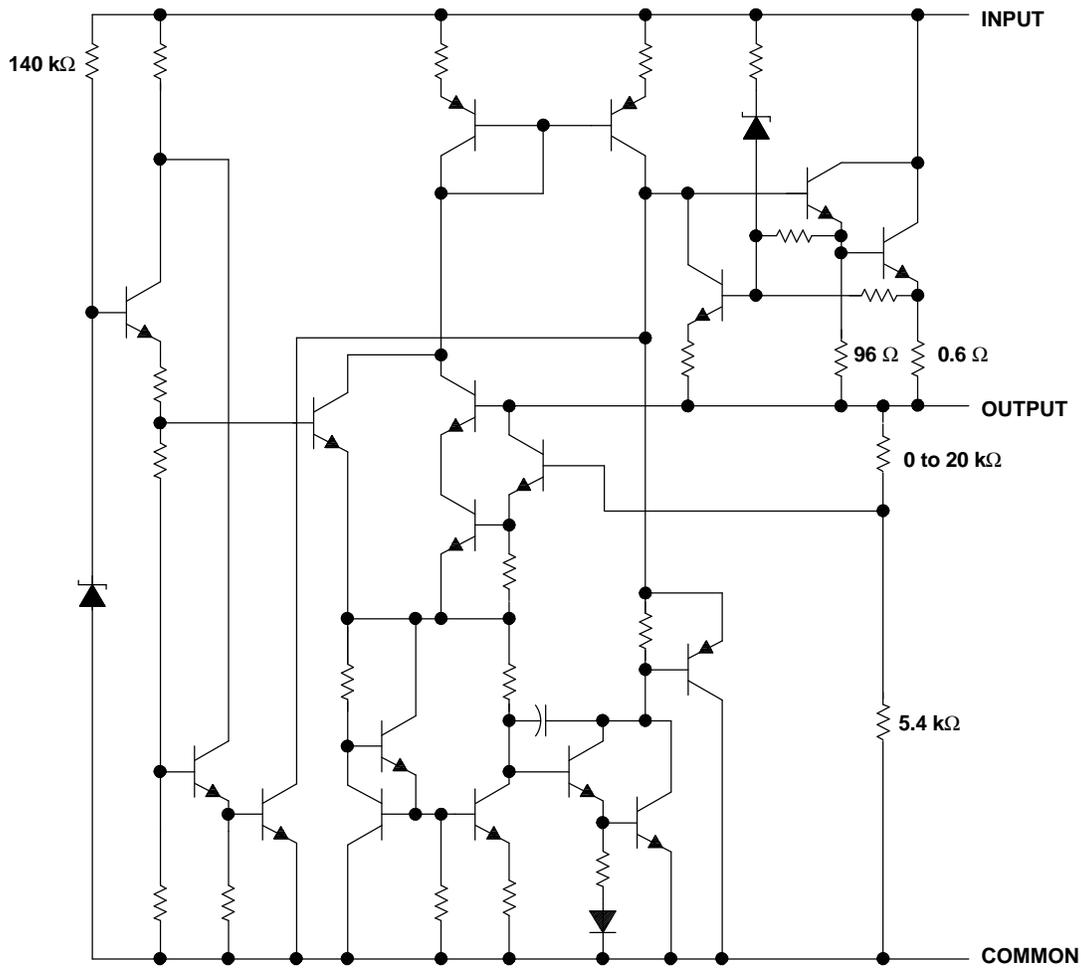
**ORDERING INFORMATION**

$T_A$	$V_O(NOM)$ (V)	PACKAGE <sup>(1)</sup>		ORDERABLE PART NUMBER	TOP-SIDE MARKING
0°C to 125°C	3.3	PowerFLEX™/TO-252 <sup>(2)</sup> – KTP	Reel of 3000	μA78M33CKTPR	UA78M33C
		SOT-223 – DCY	Tube of 80	μA78M33CDCY	C3
			Reel of 2500	μA78M33CDCYR	
		TO-220 – KC	Tube of 50	μA78M33CKC	UA78M33C
	5	PowerFLEX/TO-252 <sup>(2)</sup> – KTP	Reel of 3000	μA78M05CKTPR	UA78M05C
		SOT-223 – DCY	Tube of 80	μA78M05CDCY	C5
			Reel of 2500	μA78M05CDCYR	
		TO-220 – KC	Tube of 50	μA78M05CKC	UA78M05C
	TO-220, short shoulder – KCS	Tube of 20	μA78M05CKCS		
	6	PowerFLEX/TO-252 <sup>(2)</sup> – KTP	Reel of 3000	μA78M06CKTPR	UA78M06C
	8	PowerFLEX/TO-252 <sup>(2)</sup> – KTP	Reel of 3000	μA78M08CKTPR	UA78M08C
		SOT-223 – DCY	Tube of 80	μA78M08CDCY	C8
			Reel of 2500	μA78M08CDCYR	
	TO-220 – KC	Tube of 50	μA78M08CKC	UA78M08C	
9	PowerFLEX/TO-252 <sup>(2)</sup> – KTP	Reel of 3000	μA78M09CKTPR	UA78M09C	
10	PowerFLEX/TO-252 <sup>(2)</sup> – KTP	Reel of 3000	μA78M10CKTPR	UA78M10C	
12	PowerFLEX/TO-252 <sup>(2)</sup> – KTP	Reel of 3000	μA78M12CKTPR	UA78M12C	
	TO-220 – KC	Tube of 50	μA78M12CKC	UA78M12C	
–40°C to 125°C	5	PowerFLEX/TO-252 <sup>(2)</sup> – KTP	Reel of 3000	μA78M05IKTPR	UA78M05I
		SOT-223 – DCY	Tube of 80	μA78M05IDCY	J5
			Reel of 2500	μA78M05IDCYR	
		TO-220 – KC	Tube of 50	μA78M05IKC	UA78M05I
TO-220, short shoulder – KCS	Tube of 20	μA78M05IKCS			

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).

(2) Complies with JEDEC TO-252, variation AC

**SCHEMATIC**



Resistor values shown are nominal.

# μA78M00 SERIES POSITIVE-VOLTAGE REGULATORS

SLVS059P–JUNE 1976–REVISED OCTOBER 2005



## Absolute Maximum Ratings<sup>(1)</sup>

over virtual junction temperature range (unless otherwise noted)

		MIN	MAX	UNIT
$V_I$	Input voltage		35	V
$T_J$	Operating virtual junction temperature		150	°C
$T_{stg}$	Storage temperature range	–65	150	°C

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

## Package Thermal Data<sup>(1)</sup>

PACKAGE	BOARD	$\theta_{JP}$ <sup>(2)</sup>	$\theta_{JC}$	$\theta_{JA}$
PowerFLEX/TO-252 – KTP	High K, JESD 51-5	1.4°C/W	19°C/W	28°C/W
SOT-223 – DCY	High K, JESD 51-7		30.6°C/W	53°C/W
TO-220 – KC/KCS	High K, JESD 51-5	3°C/W	17°C/W	19°C/W

- (1) Maximum power dissipation is a function of  $T_J(\max)$ ,  $\theta_{JA}$ , and  $T_A$ . The maximum allowable power dissipation at any allowable ambient temperature is  $P_D = (T_J(\max) - T_A)/\theta_{JA}$ . Operating at the absolute maximum  $T_J$  of 150°C can affect reliability.
- (2) For packages with exposed thermal pads, such as QFN, PowerPAD™, or PowerFLEX,  $\theta_{JP}$  is defined as the thermal resistance between the die junction and the bottom of the exposed pad.

## Recommended Operating Conditions

		MIN	MAX	UNIT	
$V_I$	Input voltage	μA78M33	5.3	25	V
		μA78M05	7	25	
		μA78M06	8	25	
		μA78M08	10.5	25	
		μA78M09	11.5	26	
		μA78M10	12.5	28	
		μA78M12	14.5	30	
		μA78M15	17.5	30	
$I_O$	Output current		500	mA	
$T_J$	Operating virtual junction temperature	μA78MxxC	0	125	°C
		μA78MxxI	–40	125	

## Electrical Characteristics

at specified virtual junction temperature,  $V_I = 8\text{ V}$ ,  $I_O = 350\text{ mA}$ ,  $T_J = 25^\circ\text{C}$  (unless otherwise noted)

PARAMETER	TEST CONDITIONS <sup>(1)</sup>		μA78M33C			UNIT
			MIN	TYP	MAX	
Output voltage <sup>(2)</sup>	$I_O = 5\text{ mA to }350\text{ mA}$ , $V_I = 8\text{ V to }20\text{ V}$		3.2	3.3	3.4	V
		$T_J = 0^\circ\text{C to }125^\circ\text{C}$	3.1	3.3	3.5	
Input voltage regulation	$I_O = 200\text{ mA}$	$V_I = 5.3\text{ V to }25\text{ V}$		9	100	mV
		$V_I = 8\text{ V to }25\text{ V}$		3	50	
Ripple rejection	$V_I = 8\text{ V to }18\text{ V}$ , $f = 120\text{ Hz}$	$I_O = 100\text{ mA}$ , $T_J = 0^\circ\text{C to }125^\circ\text{C}$	62			dB
		$I_O = 300\text{ mA}$	62	80		
Output voltage regulation	$V_I = 8\text{ V}$ ,	$I_O = 5\text{ mA to }500\text{ mA}$		20	100	mV
Temperature coefficient of output voltage	$I_O = 5\text{ mA}$ ,	$T_J = 0^\circ\text{C to }125^\circ\text{C}$		–1		mV/°C
Output noise voltage	$f = 10\text{ Hz to }100\text{ kHz}$			40	200	μV
Dropout voltage				2		V
Bias current				4.5	6	mA
Bias current change	$I_O = 200\text{ mA}$ , $V_I = 8\text{ V to }25\text{ V}$ , $T_J = 0^\circ\text{C to }125^\circ\text{C}$				0.8	mA
	$I_O = 5\text{ mA to }350\text{ mA}$ ,	$T_J = 0^\circ\text{C to }125^\circ\text{C}$			0.5	
Short-circuit output current	$V_I = 35\text{ V}$			300		mA
Peak output current				700		mA

(1) All characteristics are measured with a 0.33-μF capacitor across the input and a 0.1-μF capacitor across the output. Pulse-testing techniques maintain  $T_J$  as close to  $T_A$  as possible. Thermal effects must be taken into account separately.

(2) This specification applies only for dc power dissipation permitted by absolute maximum ratings

## Electrical Characteristics

at specified virtual junction temperature,  $V_I = 10\text{ V}$ ,  $I_O = 350\text{ mA}$ ,  $T_J = 25^\circ\text{C}$  (unless otherwise noted)

PARAMETER	TEST CONDITIONS <sup>(1)</sup>		μA78M05C			UNIT
			MIN	TYP	MAX	
Output voltage	$I_O = 5\text{ mA to }350\text{ mA}$ , $V_I = 7\text{ V to }20\text{ V}$		4.8	5	5.2	V
		$T_J = 0^\circ\text{C to }125^\circ\text{C}$	4.75		5.25	
Input voltage regulation	$I_O = 200\text{ mA}$	$V_I = 7\text{ V to }25\text{ V}$		3	100	mV
		$V_I = 8\text{ V to }25\text{ V}$		1	50	
Ripple rejection	$V_I = 8\text{ V to }18\text{ V}$ , $f = 120\text{ Hz}$	$I_O = 100\text{ mA}$ , $T_J = 0^\circ\text{C to }125^\circ\text{C}$	62			dB
		$I_O = 300\text{ mA}$	62	80		
Output voltage regulation	$I_O = 5\text{ mA to }500\text{ mA}$			20	100	mV
	$I_O = 5\text{ mA to }200\text{ mA}$			10	50	
Temperature coefficient of output voltage	$I_O = 5\text{ mA}$ ,	$T_J = 0^\circ\text{C to }125^\circ\text{C}$		–1		mV/°C
Output noise voltage	$f = 10\text{ Hz to }100\text{ kHz}$			40	200	μV
Dropout voltage				2		V
Bias current				4.5	6	mA
Bias current change	$I_O = 200\text{ mA}$ , $V_I = 8\text{ V to }25\text{ V}$ , $T_J = 0^\circ\text{C to }125^\circ\text{C}$				0.8	mA
	$I_O = 5\text{ mA to }350\text{ mA}$ ,	$T_J = 0^\circ\text{C to }125^\circ\text{C}$			0.5	
Short-circuit output current	$V_I = 35\text{ V}$			300		mA
Peak output current				0.7		A

(1) All characteristics are measured with a 0.33-μF capacitor across the input and a 0.1-μF capacitor across the output. Pulse-testing techniques maintain  $T_J$  as close to  $T_A$  as possible. Thermal effects must be taken into account separately.

**Electrical Characteristics**

at specified virtual junction temperature,  $V_I = 10\text{ V}$ ,  $I_O = 350\text{ mA}$ ,  $T_J = 25^\circ\text{C}$  (unless otherwise noted)

PARAMETER	TEST CONDITIONS <sup>(1)</sup>		μA78M051			UNIT
			MIN	TYP	MAX	
Output voltage	$I_O = 5\text{ mA to }350\text{ mA}$ , $V_I = 7\text{ V to }20\text{ V}$		4.8	5	5.2	V
		$T_J = -40^\circ\text{C to }125^\circ\text{C}$	4.75		5.25	
Input voltage regulation	$I_O = 200\text{ mA}$	$V_I = 7\text{ V to }25\text{ V}$		3	100	mV
		$V_I = 8\text{ V to }25\text{ V}$		1	50	
Ripple rejection	$V_I = 8\text{ V to }18\text{ V}$ , $f = 120\text{ Hz}$	$I_O = 100\text{ mA}$ , $T_J = -40^\circ\text{C to }125^\circ\text{C}$	62			dB
		$I_O = 300\text{ mA}$	62	80		
Output voltage regulation	$I_O = 5\text{ mA to }500\text{ mA}$			20	100	mV
	$I_O = 5\text{ mA to }200\text{ mA}$			10	50	
Temperature coefficient of output voltage	$I_O = 5\text{ mA}$ ,	$T_J = -40^\circ\text{C to }125^\circ\text{C}$		-1		mV/°C
Output noise voltage	$f = 10\text{ Hz to }100\text{ kHz}$		40	200		μV
Dropout voltage			2			V
Bias current			4.5	6		mA
Bias current change	$I_O = 200\text{ mA}$ , $V_I = 8\text{ V to }25\text{ V}$ , $T_J = -40^\circ\text{C to }125^\circ\text{C}$				0.8	mA
	$I_O = 5\text{ mA to }350\text{ mA}$ , $T_J = -40^\circ\text{C to }125^\circ\text{C}$				0.5	
Short-circuit output current	$V_I = 35\text{ V}$		300			mA
Peak output current			0.7			A

(1) All characteristics are measured with a 0.33-μF capacitor across the input and a 0.1-μF capacitor across the output. Pulse-testing techniques maintain  $T_J$  as close to  $T_A$  as possible. Thermal effects must be taken into account separately.

**Electrical Characteristics**

at specified virtual junction temperature,  $V_I = 11\text{ V}$ ,  $I_O = 350\text{ mA}$ ,  $T_J = 25^\circ\text{C}$  (unless otherwise noted)

PARAMETER	TEST CONDITIONS <sup>(1)</sup>		μA78M06C			UNIT	
			MIN	TYP	MAX		
Output voltage	$I_O = 5\text{ mA to }350\text{ mA}$ ,	$V_I = 8\text{ V to }21\text{ V}$		5.75	6	6.25	V
			$T_J = 0^\circ\text{C to }125^\circ\text{C}$	5.7		6.3	
Input voltage regulation	$I_O = 200\text{ mA}$	$V_I = 8\text{ V to }25\text{ V}$		5	100	mV	
		$V_I = 9\text{ V to }25\text{ V}$		1.5	50		
Ripple rejection	$V_I = 8\text{ V to }18\text{ V}$ ,	$f = 120\text{ Hz}$	$I_O = 100\text{ mA}$ , $T_J = 0^\circ\text{C to }125^\circ\text{C}$	59		dB	
			$I_O = 300\text{ mA}$	59	80		
Output voltage regulation	$I_O = 5\text{ mA to }500\text{ mA}$			20	120	mV	
	$I_O = 5\text{ mA to }200\text{ mA}$			10	60		
Temperature coefficient of output voltage	$I_O = 5\text{ mA}$ ,	$T_J = 0^\circ\text{C to }125^\circ\text{C}$		-1		mV/°C	
Output noise voltage	$f = 10\text{ Hz to }100\text{ kHz}$		45			μV	
Dropout voltage			2			V	
Bias current			4.5	6		mA	
Bias current change	$V_I = 9\text{ V to }25\text{ V}$ , $I_O = 200\text{ mA}$ , $T_J = 0^\circ\text{C to }125^\circ\text{C}$				0.8	mA	
	$I_O = 5\text{ mA to }350\text{ mA}$ , $T_J = 0^\circ\text{C to }125^\circ\text{C}$				0.5		
Short-circuit output current	$V_I = 35\text{ V}$		270			mA	
Peak output current			0.7			A	

(1) All characteristics are measured with a 0.33-μF capacitor across the input and a 0.1-μF capacitor across the output. Pulse-testing techniques maintain  $T_J$  as close to  $T_A$  as possible. Thermal effects must be taken into account separately.

## Electrical Characteristics

at specified virtual junction temperature,  $V_I = 14\text{ V}$ ,  $I_O = 350\text{ mA}$ ,  $T_J = 25^\circ\text{C}$  (unless otherwise noted)

PARAMETER	TEST CONDITIONS <sup>(1)</sup>		μA78M08C			UNIT	
			MIN	TYP	MAX		
Output voltage	$V_I = 10.5\text{ V to }23\text{ V}$ ,	$I_O = 5\text{ mA to }350\text{ mA}$		7.7	8	8.3	V
			$T_J = 0^\circ\text{C to }125^\circ\text{C}$	7.6		8.4	
Input voltage regulation	$I_O = 200\text{ mA}$	$V_I = 10.5\text{ V to }25\text{ V}$		6	100	mV	
		$V_I = 11\text{ V to }25\text{ V}$		2	50		
Ripple rejection	$V_I = 11\text{ V to }21.5\text{ V}$ , $f = 120\text{ Hz}$	$I_O = 100\text{ mA}$ ,	$T_J = 0^\circ\text{C to }125^\circ\text{C}$		56	dB	
		$I_O = 300\text{ mA}$		56	80		
Output voltage regulation	$I_O = 5\text{ mA to }500\text{ mA}$			25	160	mV	
	$I_O = 5\text{ mA to }200\text{ mA}$			10	80		
Temperature coefficient of output voltage	$I_O = 5\text{ mA}$ ,	$T_J = 0^\circ\text{C to }125^\circ\text{C}$		-1		mV/°C	
Output noise voltage	$f = 10\text{ Hz to }100\text{ kHz}$			52		μV	
Dropout voltage				2		V	
Bias current				4.6	6	mA	
Bias current change	$V_I = 10.5\text{ V to }25\text{ V}$ ,	$I_O = 200\text{ mA}$ ,	$T_J = 0^\circ\text{C to }125^\circ\text{C}$		0.8	mA	
	$I_O = 5\text{ mA to }350\text{ mA}$ ,	$T_J = 0^\circ\text{C to }125^\circ\text{C}$			0.5		
Short-circuit output current	$V_I = 35\text{ V}$			250		mA	
Peak output current				0.7		A	

(1) All characteristics are measured with a 0.33-μF capacitor across the input and a 0.1-μF capacitor across the output. Pulse-testing techniques maintain  $T_J$  as close to  $T_A$  as possible. Thermal effects must be taken into account separately.

## Electrical Characteristics

at specified virtual junction temperature,  $V_I = 16\text{ V}$ ,  $I_O = 350\text{ mA}$ ,  $T_J = 25^\circ\text{C}$  (unless otherwise noted)

PARAMETER	TEST CONDITIONS <sup>(1)</sup>		μA78M09C			UNIT	
			MIN	TYP	MAX		
Output voltage	$V_I = 11.5\text{ V to }24\text{ V}$ ,	$I_O = 5\text{ mA to }350\text{ mA}$		8.6	9	9.4	V
			$T_J = 0^\circ\text{C to }125^\circ\text{C}$	8.5		9.5	
Input voltage regulation	$I_O = 200\text{ mA}$	$V_I = 11.5\text{ V to }26\text{ V}$		6	100	mV	
		$V_I = 12\text{ V to }26\text{ V}$		2	50		
Ripple rejection	$V_I = 13\text{ V to }23\text{ V}$ , $f = 120\text{ Hz}$	$I_O = 100\text{ mA}$ ,	$T_J = 0^\circ\text{C to }125^\circ\text{C}$		56	dB	
		$I_O = 300\text{ mA}$		56	80		
Output voltage regulation	$I_O = 5\text{ mA to }500\text{ mA}$			25	180	mV	
	$I_O = 5\text{ mA to }200\text{ mA}$			10	90		
Temperature coefficient of output voltage	$I_O = 5\text{ mA}$ ,	$T_J = 0^\circ\text{C to }125^\circ\text{C}$		-1		mV/°C	
Output noise voltage	$f = 10\text{ Hz to }100\text{ kHz}$			58		μV	
Dropout voltage				2		V	
Bias current				4.6	6	mA	
Bias current change	$V_I = 11.5\text{ V to }26\text{ V}$ ,	$I_O = 200\text{ mA}$ ,	$T_J = 0^\circ\text{C to }125^\circ\text{C}$		0.8	mA	
	$I_O = 5\text{ mA to }350\text{ mA}$ ,	$T_J = 0^\circ\text{C to }125^\circ\text{C}$			0.5		
Short-circuit output current	$V_I = 35\text{ V}$			250		mA	
Peak output current				0.7		A	

(1) All characteristics are measured with a 0.33-μF capacitor across the input and a 0.1-μF capacitor across the output. Pulse-testing techniques maintain  $T_J$  as close to  $T_A$  as possible. Thermal effects must be taken into account separately.

# μA78M00 SERIES POSITIVE-VOLTAGE REGULATORS

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## Electrical Characteristics

at specified virtual junction temperature,  $V_I = 17\text{ V}$ ,  $I_O = 350\text{ mA}$ ,  $T_J = 25^\circ\text{C}$  (unless otherwise noted)

PARAMETER	TEST CONDITIONS <sup>(1)</sup>		μA78M10C			UNIT
			MIN	TYP	MAX	
Output voltage	$V_I = 12.5\text{ V to }25\text{ V}$ , $I_O = 5\text{ mA to }350\text{ mA}$	$T_J = 0^\circ\text{C to }125^\circ\text{C}$	9.6	10	10.4	V
			9.5		10.5	
Input voltage regulation	$I_O = 200\text{ mA}$	$V_I = 12.5\text{ V to }28\text{ V}$	7	100	mV	
		$V_I = 14\text{ V to }28\text{ V}$	2	50		
Ripple rejection	$V_I = 15\text{ V to }25\text{ V}$ , $f = 120\text{ Hz}$	$I_O = 100\text{ mA}$ , $I_O = 300\text{ mA}$ , $T_J = 0^\circ\text{C to }125^\circ\text{C}$	59		dB	
			55	80		
Output voltage regulation	$I_O = 5\text{ mA to }500\text{ mA}$		25	200	mV	
	$I_O = 5\text{ mA to }200\text{ mA}$		10	100		
Temperature coefficient of output voltage	$I_O = 5\text{ mA}$ , $T_J = 0^\circ\text{C to }125^\circ\text{C}$		-1		mV/°C	
Output noise voltage	$f = 10\text{ Hz to }100\text{ kHz}$		64		μV	
Dropout voltage			2		V	
Bias current			4.7	6	mA	
Bias current change	$V_I = 12.5\text{ V to }28\text{ V}$ , $I_O = 5\text{ mA to }350\text{ mA}$ , $T_J = 0^\circ\text{C to }125^\circ\text{C}$	$I_O = 200\text{ mA}$ , $T_J = 0^\circ\text{C to }125^\circ\text{C}$		0.8	mA	
				0.5		
Short-circuit output current	$V_I = 35\text{ V}$		245		mA	
Peak output current			0.7		A	

(1) All characteristics are measured with a 0.33-μF capacitor across the input and a 0.1-μF capacitor across the output. Pulse-testing techniques maintain  $T_J$  as close to  $T_A$  as possible. Thermal effects must be taken into account separately.

## Electrical Characteristics

at specified virtual junction temperature,  $V_I = 19\text{ V}$ ,  $I_O = 350\text{ mA}$ ,  $T_J = 25^\circ\text{C}$  (unless otherwise noted)

PARAMETER	TEST CONDITIONS <sup>(1)</sup>		μA78M12C			UNIT
			MIN	TYP	MAX	
Output voltage	$V_I = 14.5\text{ V to }27\text{ V}$ , $I_O = 5\text{ mA to }350\text{ mA}$	$T_J = 0^\circ\text{C to }125^\circ\text{C}$	11.5	12	12.5	V
			11.4		12.6	
Input voltage regulation	$I_O = 200\text{ mA}$	$V_I = 14.5\text{ V to }30\text{ V}$	8	100	mV	
		$V_I = 16\text{ V to }30\text{ V}$	2	50		
Ripple rejection	$V_I = 15\text{ V to }25\text{ V}$ , $f = 120\text{ Hz}$	$I_O = 100\text{ mA}$ , $I_O = 300\text{ mA}$ , $T_J = 0^\circ\text{C to }125^\circ\text{C}$	55		dB	
			55	80		
Output voltage regulation	$I_O = 5\text{ mA to }500\text{ mA}$		25	240	mV	
	$I_O = 5\text{ mA to }200\text{ mA}$		10	120		
Temperature coefficient of output voltage	$I_O = 5\text{ mA}$ , $T_J = 0^\circ\text{C to }125^\circ\text{C}$		-1		mV/°C	
Output noise voltage	$f = 10\text{ Hz to }100\text{ kHz}$		75		μV	
Dropout voltage			2		V	
Bias current			4.8	6	mA	
Bias current change	$V_I = 14.5\text{ V to }30\text{ V}$ , $I_O = 5\text{ mA to }350\text{ mA}$ , $T_J = 0^\circ\text{C to }125^\circ\text{C}$	$I_O = 200\text{ mA}$ , $T_J = 0^\circ\text{C to }125^\circ\text{C}$		0.8	mA	
				0.5		
Short-circuit output current	$V_I = 35\text{ V}$		240		mA	
Peak output current			0.7		A	

(1) All characteristics are measured with a 0.33-μF capacitor across the input and a 0.1-μF capacitor across the output. Pulse-testing techniques maintain  $T_J$  as close to  $T_A$  as possible. Thermal effects must be taken into account separately.

The μA78M15 is obsolete and no longer supplied.

## Electrical Characteristics

at specified virtual junction temperature,  $V_I = 23\text{ V}$ ,  $I_O = 350\text{ mA}$ ,  $T_J = 25^\circ\text{C}$  (unless otherwise noted)

PARAMETER	TEST CONDITIONS <sup>(1)</sup>		μA78M15C			UNIT
			MIN	TYP	MAX	
Output voltage	$V_I = 17.5\text{ V to }30\text{ V}$ , $I_O = 5\text{ mA to }350\text{ mA}$	$T_J = 0^\circ\text{C to }125^\circ\text{C}$	14.4	15	15.6	V
			14.25		15.75	
Input voltage regulation	$I_O = 200\text{ mA}$	$V_I = 17.5\text{ V to }30\text{ V}$		10	100	mV
		$V_I = 20\text{ V to }30\text{ V}$		3	50	
Ripple rejection	$V_I = 18.5\text{ V to }28.5\text{ V}$ , $f = 120\text{ Hz}$	$I_O = 100\text{ mA}$ , $T_J = 0^\circ\text{C to }125^\circ\text{C}$	54			dB
		$I_O = 300\text{ mA}$	54	70		
Output voltage regulation	$I_O = 5\text{ mA to }500\text{ mA}$			25	300	mV
	$I_O = 5\text{ mA to }200\text{ mA}$			10	150	
Temperature coefficient of output voltage	$I_O = 5\text{ mA}$ , $T_J = 0^\circ\text{C to }125^\circ\text{C}$			–1		mV/°C
Output noise voltage	$f = 10\text{ Hz to }100\text{ kHz}$			90		μV
Dropout voltage				2		V
Bias current				4.8	6	mA
Bias current change	$V_I = 17.5\text{ V to }30\text{ V}$ , $I_O = 5\text{ mA to }350\text{ mA}$ , $T_J = 0^\circ\text{C to }125^\circ\text{C}$	$I_O = 200\text{ mA}$ , $T_J = 0^\circ\text{C to }125^\circ\text{C}$			0.8	mA
					0.5	
Short-circuit output current	$V_I = 35\text{ V}$			240		mA
Peak output current				0.7		A

(1) All characteristics are measured with a 0.33-μF capacitor across the input and a 0.1-μF capacitor across the output. Pulse-testing techniques maintain  $T_J$  as close to  $T_A$  as possible. Thermal effects must be taken into account separately.

**PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
UA78M05CDCY	ACTIVE	SOT-223	DCY	4	80	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1YEAR
UA78M05CDCYG3	ACTIVE	SOT-223	DCY	4	80	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1YEAR
UA78M05CDCYR	ACTIVE	SOT-223	DCY	4	2500	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1YEAR
UA78M05CDCYRG3	ACTIVE	SOT-223	DCY	4	2500	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1YEAR
UA78M05CKC	NRND	TO-220	KC	3	50	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
UA78M05CKCS	ACTIVE	TO-220	KCS	3	50	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
UA78M05CKTPR	NRND	PFM	KTP	2	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM
UA78M05CKTPRG3	NRND	PFM	KTP	2	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM
UA78M05CKVURG3	ACTIVE	PFM	KVU	3	2500	Green (RoHS & no Sb/Br)	CU SN	Level-3-260C-168 HR
UA78M05IDCY	ACTIVE	SOT-223	DCY	4	80	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1YEAR
UA78M05IDCYG3	ACTIVE	SOT-223	DCY	4	80	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1YEAR
UA78M05IDCYR	ACTIVE	SOT-223	DCY	4	2500	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1YEAR
UA78M05IDCYRG3	ACTIVE	SOT-223	DCY	4	2500	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1YEAR
UA78M05IKC	NRND	TO-220	KC	3	50	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
UA78M05IKCE3	NRND	TO-220	KC	3	50	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
UA78M05IKCS	ACTIVE	TO-220	KCS	3	50	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
UA78M05IKCSE3	ACTIVE	TO-220	KCS	3	50	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
UA78M05IKTPR	NRND	PFM	KTP	2	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM
UA78M05IKTPRG3	NRND	PFM	KTP	2	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM
UA78M05IKVURG3	ACTIVE	PFM	KVU	3	2500	Green (RoHS & no Sb/Br)	CU SN	Level-3-260C-168 HR
UA78M06CKC	OBSOLETE	TO-220	KC	3		TBD	Call TI	Call TI
UA78M06CKTPR	NRND	PFM	KTP	2	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM
UA78M06CKTPRG3	NRND	PFM	KTP	2	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM
UA78M06CKVURG3	ACTIVE	PFM	KVU	3	2500	Green (RoHS & no Sb/Br)	CU SN	Level-3-260C-168 HR
UA78M08CDCY	ACTIVE	SOT-223	DCY	4	80	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1YEAR

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
UA78M08CDCYG3	ACTIVE	SOT-223	DCY	4	80	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1YEAR
UA78M08CDCYR	ACTIVE	SOT-223	DCY	4	2500	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1YEAR
UA78M08CDCYRG3	ACTIVE	SOT-223	DCY	4	2500	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1YEAR
UA78M08CKC	NRND	TO-220	KC	3	50	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
UA78M08CKCE3	NRND	TO-220	KC	3	50	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
UA78M08CKCS	ACTIVE	TO-220	KCS	3	50	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
UA78M08CKTPR	NRND	PFM	KTP	2	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM
UA78M08CKTPRG3	NRND	PFM	KTP	2	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM
UA78M08CKVURG3	ACTIVE	PFM	KVU	3	2500	Green (RoHS & no Sb/Br)	CU SN	Level-3-260C-168 HR
UA78M09CKC	OBSOLETE	TO-220	KC	3		TBD	Call TI	Call TI
UA78M09CKTP	OBSOLETE	PFM	KTP	2		TBD	Call TI	Call TI
UA78M09CKTPR	NRND	PFM	KTP	2	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM
UA78M09CKTPRG3	NRND	PFM	KTP	2	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM
UA78M09CKVURG3	ACTIVE	PFM	KVU	3	2500	Green (RoHS & no Sb/Br)	CU SN	Level-3-260C-168 HR
UA78M10CKC	OBSOLETE	TO-220	KC	3		TBD	Call TI	Call TI
UA78M10CKTPR	NRND	PFM	KTP	2	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM
UA78M10CKTPRG3	NRND	PFM	KTP	2	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM
UA78M10CKVURG3	ACTIVE	PFM	KVU	3	2500	Green (RoHS & no Sb/Br)	CU SN	Level-3-260C-168 HR
UA78M12CKC	NRND	TO-220	KC	3	50	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
UA78M12CKCS	ACTIVE	TO-220	KCS	3	50	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
UA78M12CKTPR	NRND	PFM	KTP	2	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM
UA78M12CKTPRG3	NRND	PFM	KTP	2	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM
UA78M12CKVURG3	ACTIVE	PFM	KVU	3	2500	Green (RoHS & no Sb/Br)	CU SN	Level-3-260C-168 HR
UA78M33CDCY	ACTIVE	SOT-223	DCY	4	80	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1YEAR
UA78M33CDCYG3	ACTIVE	SOT-223	DCY	4	80	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1YEAR
UA78M33CDCYR	ACTIVE	SOT-223	DCY	4	2500	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1YEAR
UA78M33CDCYRG3	ACTIVE	SOT-223	DCY	4	2500	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1YEAR

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
UA78M33CKC	NRND	TO-220	KC	3	50	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
UA78M33CKCE3	NRND	TO-220	KC	3	50	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
UA78M33CKCS	ACTIVE	TO-220	KCS	3	50	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
UA78M33CKCSE3	ACTIVE	TO-220	KCS	3	50	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
UA78M33CKTPR	NRND	PFM	KTP	2	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM
UA78M33CKTPRG3	NRND	PFM	KTP	2	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM
UA78M33CKVURG3	ACTIVE	PFM	KVU	3	2500	Green (RoHS & no Sb/Br)	CU SN	Level-3-260C-168 HR

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

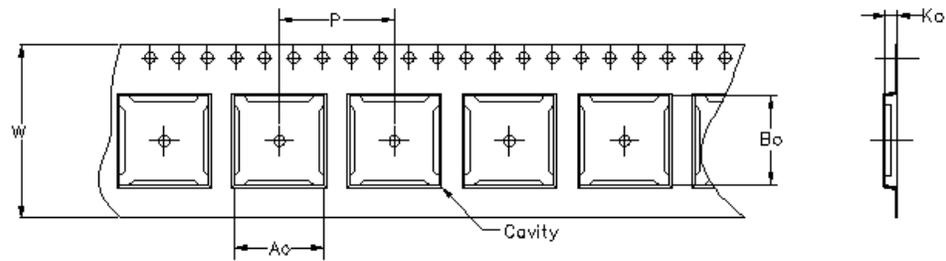
**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

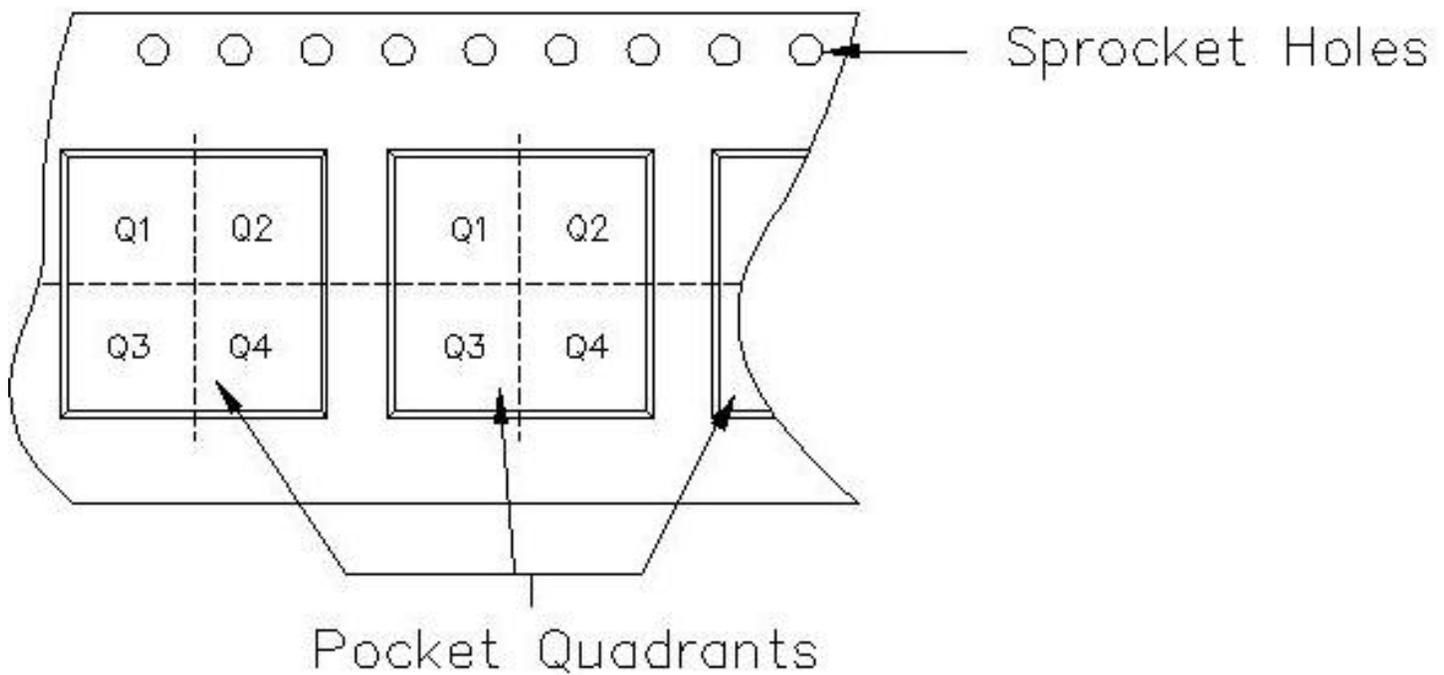
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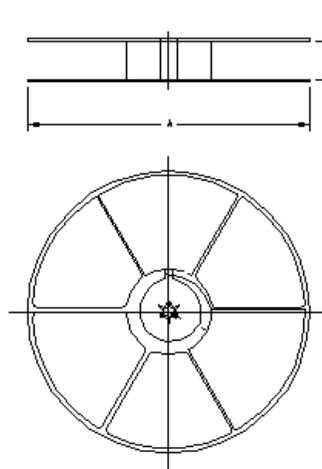
Carrier tape design is defined largely by the component length, width, and thickness.

$A_o$ = Dimension designed to accommodate the component width.
$B_o$ = Dimension designed to accommodate the component length.
$K_o$ = Dimension designed to accommodate the component thickness.
$W$ = Overall width of the carrier tape.
$P$ = Pitch between successive cavity centers.



**TAPE AND REEL INFORMATION**

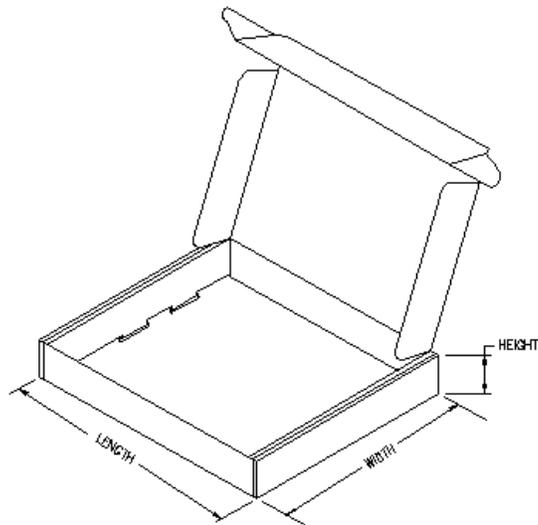
Device	Package	Pins	Site	Reel Diameter (mm)	Reel Width (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
UA78M05CKTPR	KTP	2	SEM	330	16	6.5	10.0	2.45	8	16	NONE
UA78M05CKTPRG3	KTP	2	SEM	330	16	6.5	10.0	2.45	8	16	NONE
UA78M05IKTPR	KTP	2	SEM	330	16	6.5	10.0	2.45	8	16	NONE
UA78M05IKTPRG3	KTP	2	SEM	330	16	6.5	10.0	2.45	8	16	NONE
UA78M06CKTPR	KTP	2	SEM	330	16	6.5	10.0	2.45	8	16	NONE
UA78M06CKTPRG3	KTP	2	SEM	330	16	6.5	10.0	2.45	8	16	NONE
UA78M08CKTPR	KTP	2	SEM	330	16	6.5	10.0	2.45	8	16	NONE
UA78M08CKTPRG3	KTP	2	SEM	330	16	6.5	10.0	2.45	8	16	NONE
UA78M09CKTPR	KTP	2	SEM	330	16	6.5	10.0	2.45	8	16	NONE
UA78M09CKTPRG3	KTP	2	SEM	330	16	6.5	10.0	2.45	8	16	NONE
UA78M10CKTPR	KTP	2	SEM	330	16	6.5	10.0	2.45	8	16	NONE
UA78M10CKTPRG3	KTP	2	SEM	330	16	6.5	10.0	2.45	8	16	NONE
UA78M12CKTPR	KTP	2	SEM	330	16	6.5	10.0	2.45	8	16	NONE
UA78M12CKTPRG3	KTP	2	SEM	330	16	6.5	10.0	2.45	8	16	NONE
UA78M33CKTPR	KTP	2	SEM	330	16	6.5	10.0	2.45	8	16	NONE
UA78M33CKTPRG3	KTP	2	SEM	330	16	6.5	10.0	2.45	8	16	NONE



**TAPE AND REEL BOX INFORMATION**

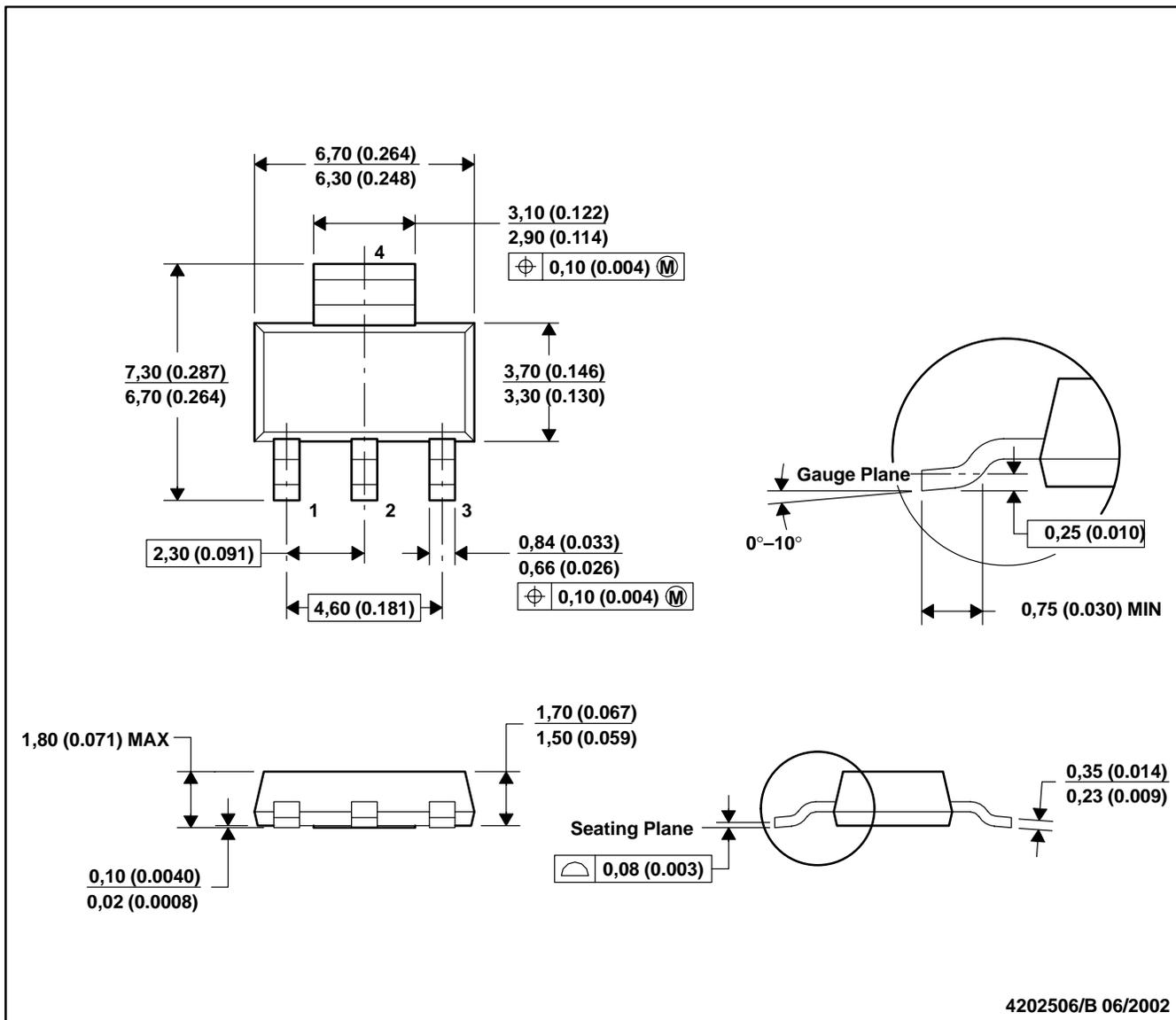
Device	Package	Pins	Site	Length (mm)	Width (mm)	Height (mm)
UA78M05CKTPR	KTP	2	SEM	333.2	333.2	28.58
UA78M05CKTPRG3	KTP	2	SEM	333.2	333.2	28.58
UA78M05IKTPR	KTP	2	SEM	333.2	333.2	28.58
UA78M05IKTPRG3	KTP	2	SEM	333.2	333.2	28.58
UA78M06CKTPR	KTP	2	SEM	333.2	333.2	28.58

Device	Package	Pins	Site	Length (mm)	Width (mm)	Height (mm)
UA78M06CKTPRG3	KTP	2	SEM	333.2	333.2	28.58
UA78M08CKTPR	KTP	2	SEM	333.2	333.2	28.58
UA78M08CKTPRG3	KTP	2	SEM	333.2	333.2	28.58
UA78M09CKTPR	KTP	2	SEM	333.2	333.2	28.58
UA78M09CKTPRG3	KTP	2	SEM	333.2	333.2	28.58
UA78M10CKTPR	KTP	2	SEM	333.2	333.2	28.58
UA78M10CKTPRG3	KTP	2	SEM	333.2	333.2	28.58
UA78M12CKTPR	KTP	2	SEM	333.2	333.2	28.58
UA78M12CKTPRG3	KTP	2	SEM	333.2	333.2	28.58
UA78M33CKTPR	KTP	2	SEM	333.2	333.2	28.58
UA78M33CKTPRG3	KTP	2	SEM	333.2	333.2	28.58



DCY (R-PDSO-G4)

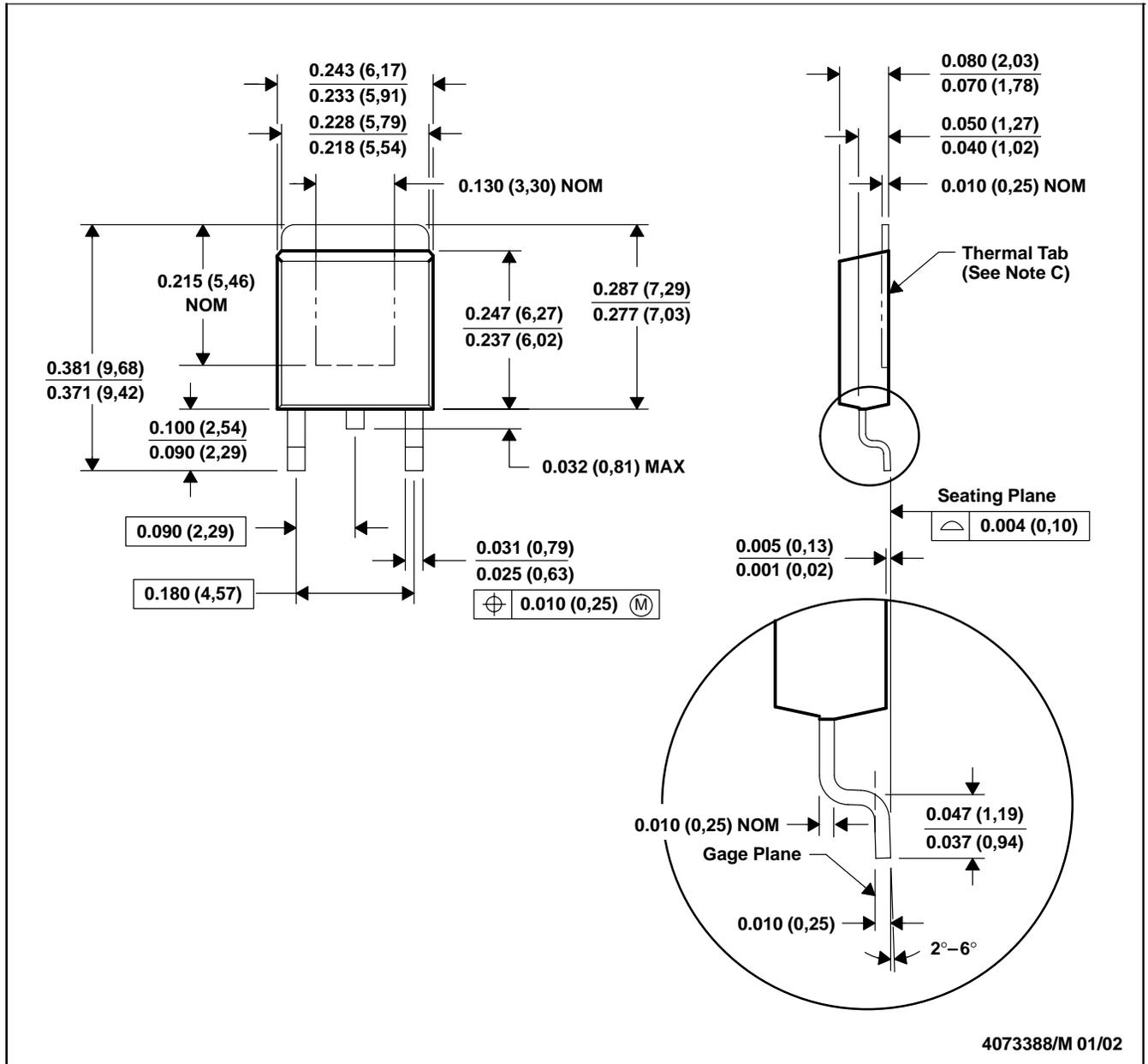
PLASTIC SMALL-OUTLINE



- NOTES: A. All linear dimensions are in millimeters (inches).  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion.  
 D. Falls within JEDEC TO-261 Variation AA.

KTP (R-PSFM-G2)

PowerFLEX™ PLASTIC FLANGE-MOUNT PACKAGE

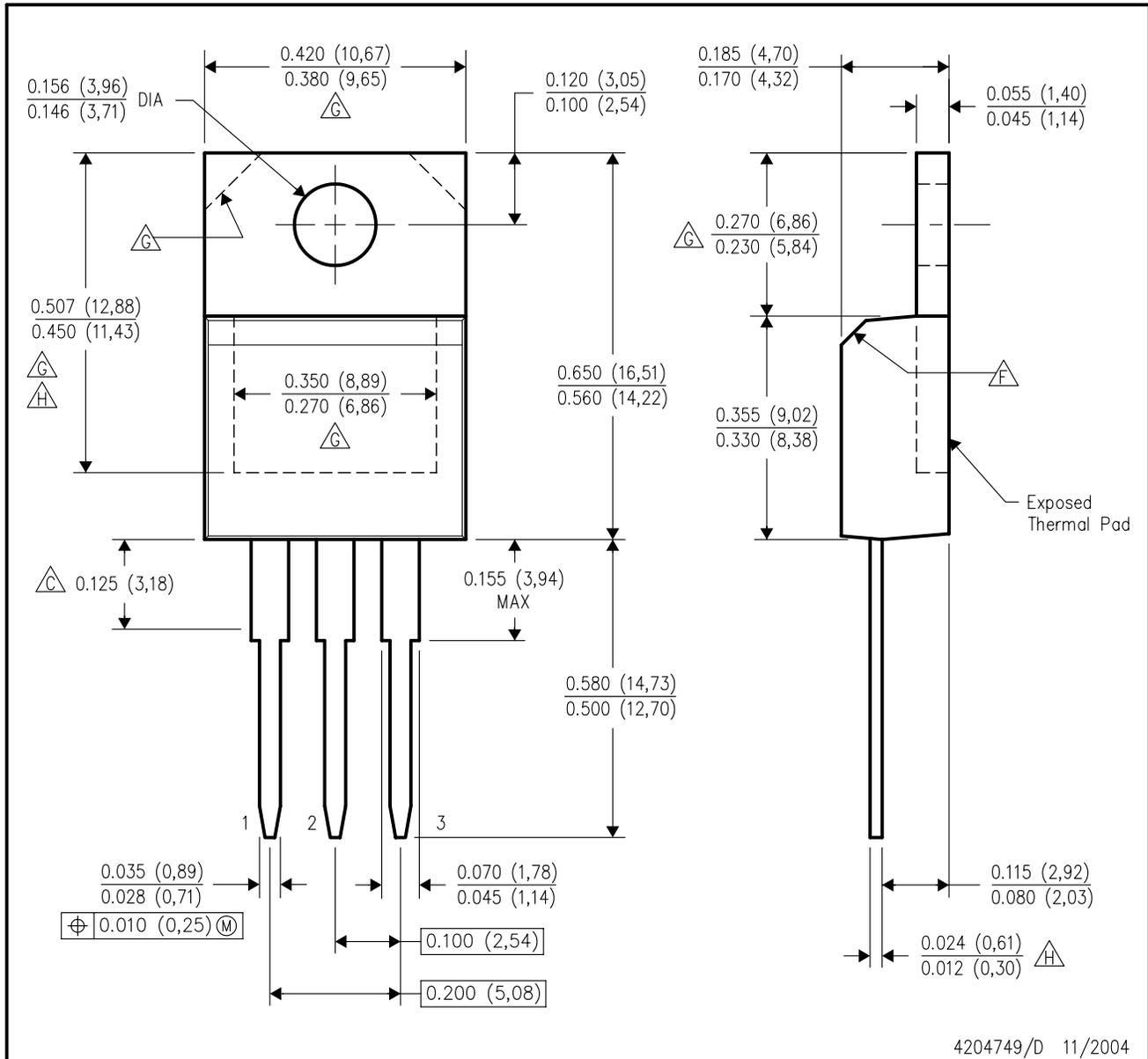


- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. The center lead is in electrical contact with the thermal tab.  
 D. Dimensions do not include mold protrusions, not to exceed 0.006 (0,15).  
 E. Falls within JEDEC TO-252 variation AC.

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KCS (R-PSFM-T3)

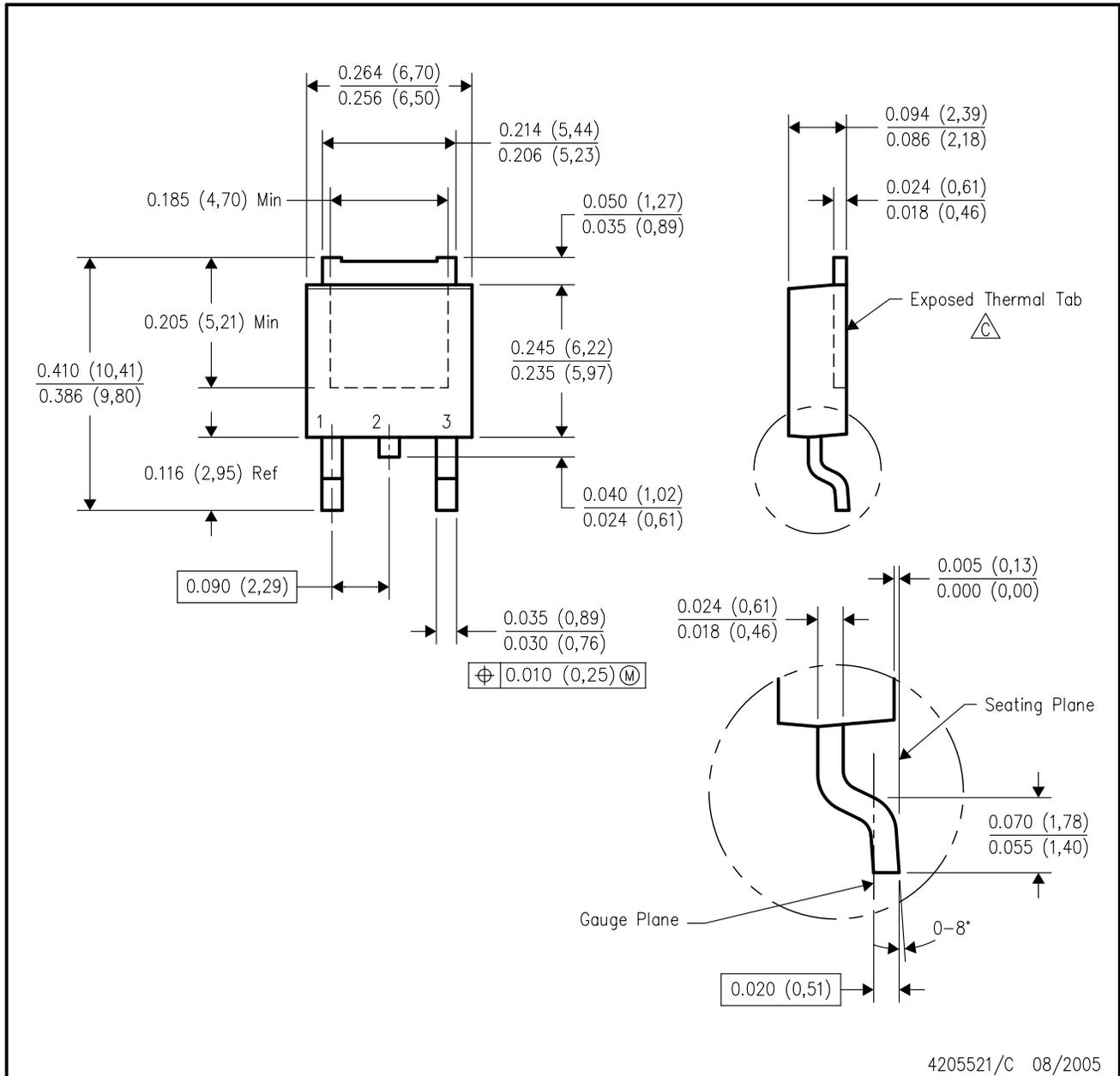
PLASTIC FLANGE-MOUNT PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Lead dimensions are not controlled within this area.
  - D. All lead dimensions apply before solder dip.
  - E. The center lead is in electrical contact with the mounting tab.
  - F. The chamfer is optional.
  - G. Thermal pad contour optional within these dimensions.
  - H. Falls within JEDEC TO-220 variation AB, except minimum lead thickness and minimum exposed pad length.

KVU (R-PSFM-G3)

PLASTIC FLANGE-MOUNT PACKAGE

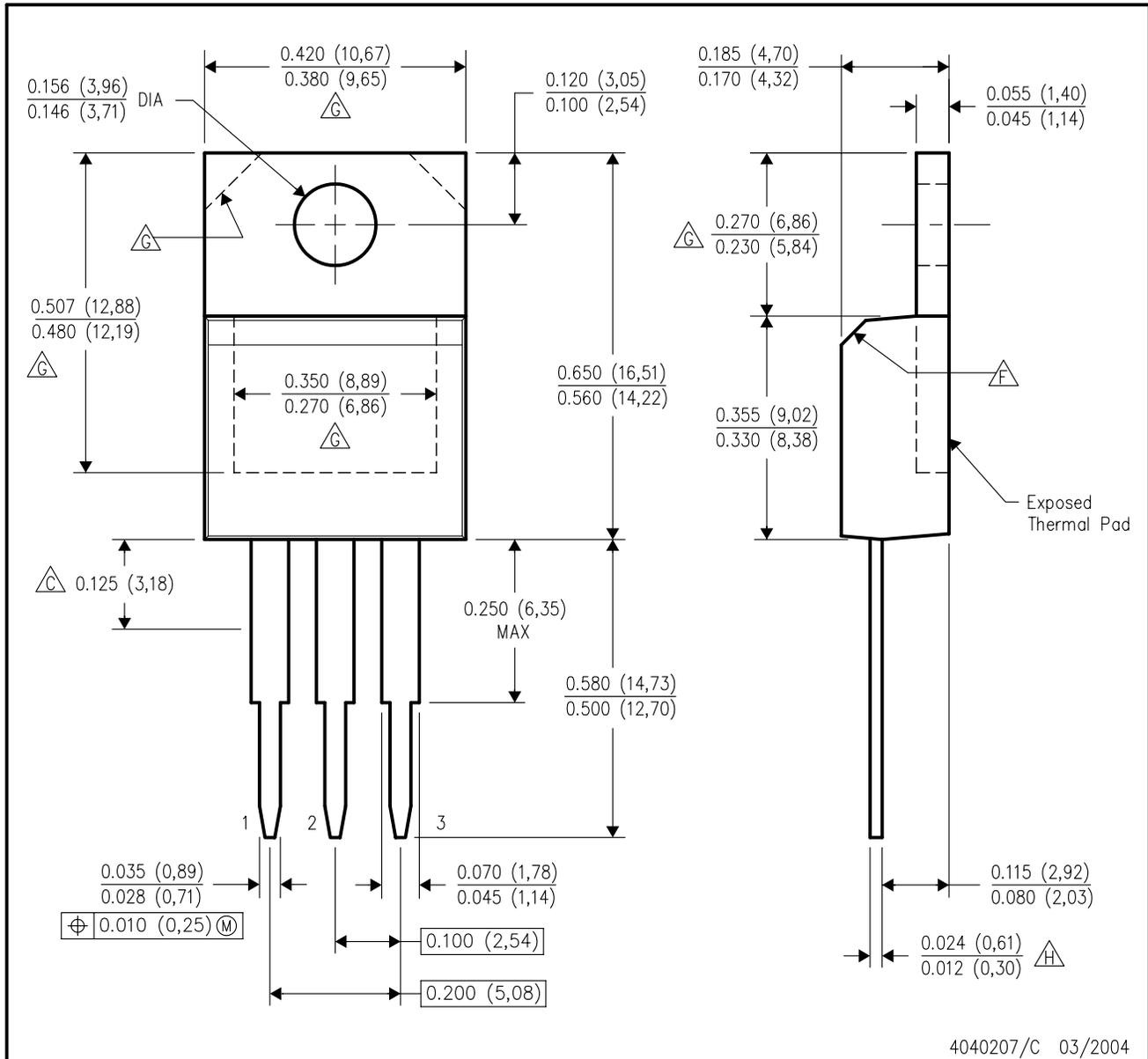


4205521/C 08/2005

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - △ The center lead is in electrical contact with the exposed thermal tab.
  - D. Body Dimensions do not include mold flash or protrusions. Mold flash and protrusion shall not exceed 0.006 (0,15) per side.
  - E. Falls within JEDEC TO-252 variation AA.

KC (R-PSFM-T3)

PLASTIC FLANGE-MOUNT PACKAGE



- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - Lead dimensions are not controlled within this area.
  - All lead dimensions apply before solder dip.
  - The center lead is in electrical contact with the mounting tab.
  - The chamfer is optional.
  - Thermal pad contour optional within these dimensions.
  - Falls within JEDEC TO-220 variation AB, except minimum lead thickness.

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Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265  
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